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# STP80NF06 - STB80NF06 STW80NF06

N-channel 60V - 0.0065Ω - 80A TO-220/D<sup>2</sup>PAK/TO-247 STripFET II™ Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STB80NF06	60V	<0.008Ω	80A
STP80NF06	60V	<0.008Ω	80A
STW80NF06	60V	<0.008Ω	80A

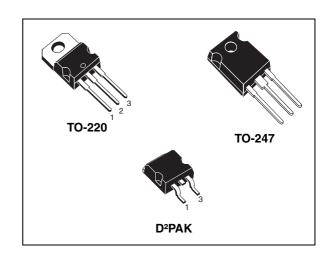
- 100% avalanche tested
- Low threshold drive

#### **Description**

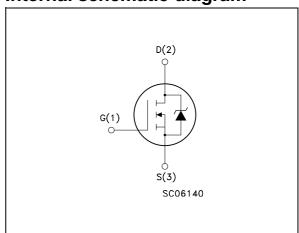
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## **Applications**

■ Switching application



### Internal schematic diagram



#### Order codes

Part number	Marking	Package	Packaging
STB80NF06T4	B80NF06	D <sup>2</sup> PAK	Tape & reel
STP80NF06	P80NF06	TO-220	Tube
STW80NF06	W80NF06	TO-247	Tube

## **Contents**

1	Electrical ratings
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuit
4	Package mechanical data
5	Revision history

# 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (v <sub>gs</sub> = 0)	60	V
V <sub>GS</sub>	Gate- source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25°C	80	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100°C	80	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	300	W
	Derating factor	2	W/°C
E <sub>AS</sub> (3)	Single pulse avalanche energy	870	mJ
T <sub>stg</sub>	Storage temperature	- 65 to 175	°C
T <sub>j</sub>	Max. operating junction temperature	175	

- 1. Current limited by wire bonding
- 2. Pulse width limited by safe operating area
- 3. Starting  $T_i$ = 25°C,  $I_D$ = 40A,  $V_{DD}$ =40V

Table 2. Thermal data

R <sub>thj-case</sub>	Thermal resistance junction-case Max	0.5	°C/W
R <sub>thj-a</sub>	Thermal resistance junction-ambient Max	62.5	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300	°C

## 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	60			V
I <sub>DSS</sub>	Zero gate voltage Drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ =Max rating, $T_{C}$ =125°C			1 10	μA μA
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±20V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	٧
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10V, I_D = 40A$		0.0065	0.008	Ω

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	$V_{DS} = 2.5V_{,} I_{D} = 18A$		20		S
C <sub>iss</sub>	Input capacitance			3850		pF
C <sub>oss</sub>	Output capacitance	$V_{DS} = 25V, f = 1 \text{ MHz}, V_{GS} = 0$		800		pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0$		250		pF
Qg	Total gate charge	V 00V I 00A		115	150	nC
$Q_{gs}$	Gate-source charge	$V_{DD} = 80V, I_{D} = 80A,$ $V_{GS} = 10V$		24		nC
$Q_{gd}$	Gate-drain charge	·GS = 10 ·		46		nC

<sup>1.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD} = 27V$ , $I_D = 40A$ $R_G = 4.7\Omega V_{GS} = 10V$ (see Figure 13)		25 85		ns ns
t <sub>d(off)</sub>	Turn-off-delay time Fall time	$V_{DD}$ = 27V, $I_D$ = 40A, $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10V (see Figure 13)		70 25		ns ns
t <sub>d(off)</sub> t <sub>f</sub> t <sub>c</sub>	Off-voltage Rise Time Fall Time Cross-over Time	Vclamp =44V, $I_D$ =80A $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 10V (see Figure 15)		85 75 110		ns ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				80	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				320	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 80A, V_{GS} = 0$			1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 80A$ , $V_{DD} = 50V$ di/dt = 100A/ $\mu$ s, $T_j = 150$ °C (see Figure 15)		80 250 6.4		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area.

<sup>2.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

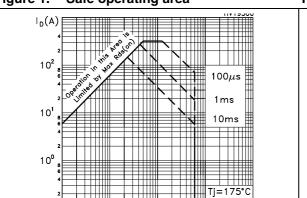


Figure 2. Thermal impedance

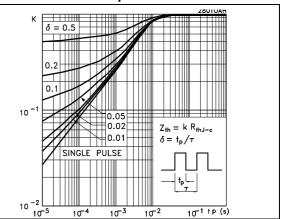


Figure 3. Output characteristics

Figure 4. Transfer characteristics

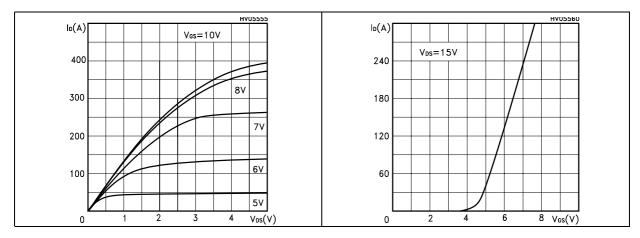


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

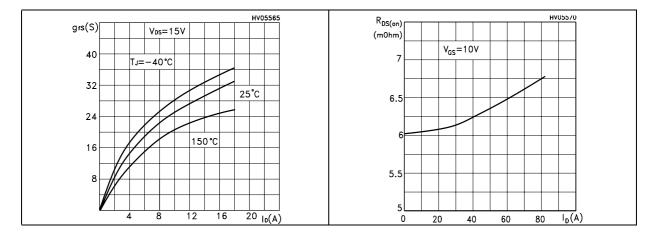


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

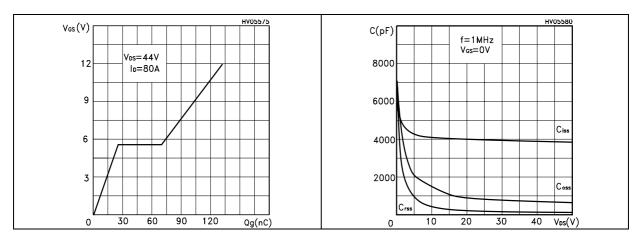


Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs. vs. temperature temperature

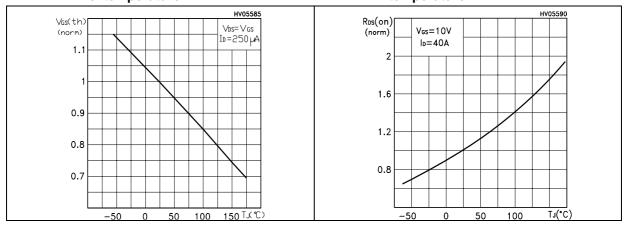
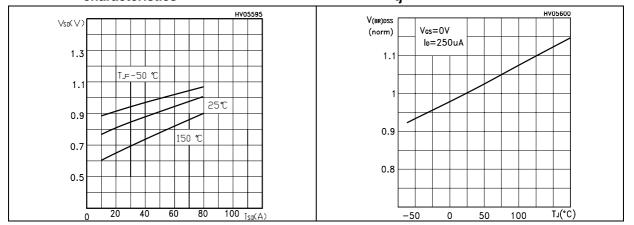


Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage vs. ti



### 3 Test circuit

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

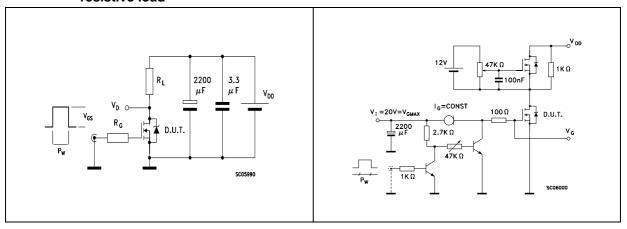


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

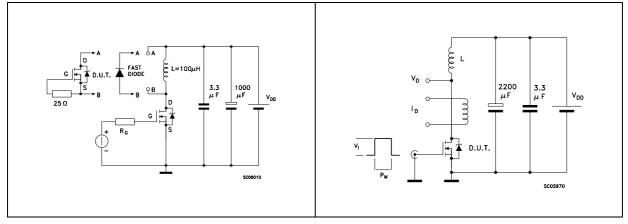
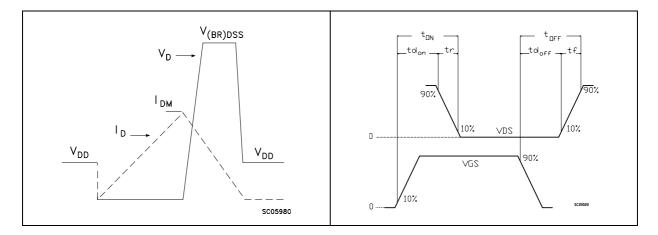


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform

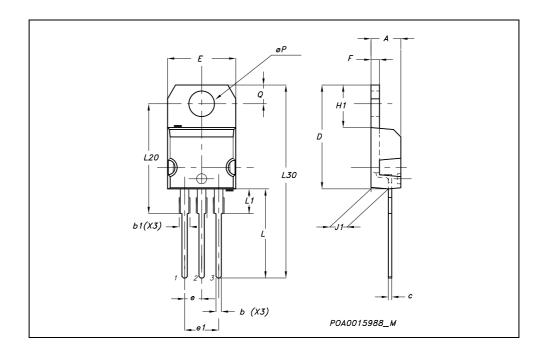


## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

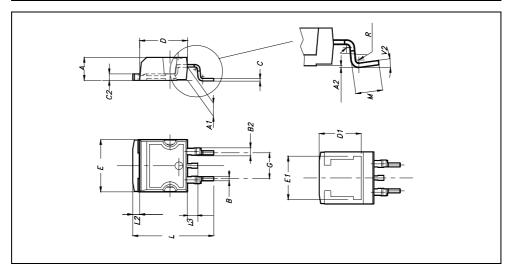
#### **TO-220 MECHANICAL DATA**

DIM.		mm.		inch			
DINI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
Α	4.40		4.60	0.173		0.181	
b	0.61		0.88	0.024		0.034	
b1	1.15		1.70	0.045		0.066	
С	0.49		0.70	0.019		0.027	
D	15.25		15.75	0.60		0.620	
E	10		10.40	0.393		0.409	
е	2.40		2.70	0.094		0.106	
e1	4.95		5.15	0.194		0.202	
F	1.23		1.32	0.048		0.052	
H1	6.20		6.60	0.244		0.256	
J1	2.40		2.72	0.094		0.107	
L	13		14	0.511		0.551	
L1	3.50		3.93	0.137		0.154	
L20		16.40			0.645		
L30		28.90			1.137		
øΡ	3.75		3.85	0.147		0.151	
Q	2.65		2.95	0.104		0.116	



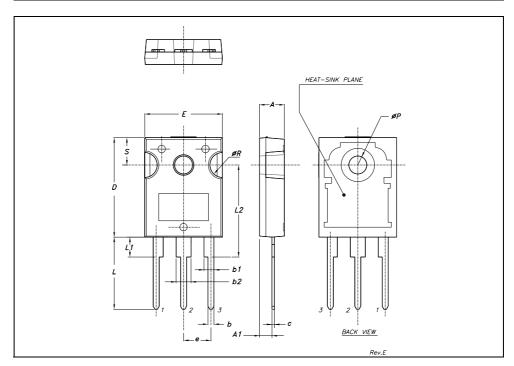
## D<sup>2</sup>PAK MECHANICAL DATA

DIM.		mm.			inch			
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
Α	4.4		4.6	0.173		0.181		
A1	2.49		2.69	0.098		0.106		
A2	0.03		0.23	0.001		0.009		
В	0.7		0.93	0.027		0.036		
B2	1.14		1.7	0.044		0.067		
С	0.45		0.6	0.017		0.023		
C2	1.23		1.36	0.048		0.053		
D	8.95		9.35	0.352		0.368		
D1		8			0.315			
E	10		10.4	0.393				
E1		8.5			0.334			
G	4.88		5.28	0.192		0.208		
L	15		15.85	0.590		0.625		
L2	1.27		1.4	0.050		0.055		
L3	1.4		1.75	0.055		0.068		
М	2.4		3.2	0.094		0.126		
R		0.4			0.015			
V2	00		4º					



#### **TO-247 MECHANICAL DATA**

DIM.		mm.		inch			
DIWI.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
Α	4.85		5.15	0.19		0.20	
A1	2.20		2.60	0.086		0.102	
b	1.0		1.40	0.039		0.055	
b1	2.0		2.40	0.079		0.094	
b2	3.0		3.40	0.118		0.134	
С	0.40		0.80	0.015		0.03	
D	19.85		20.15	0.781		0.793	
Е	15.45		15.75	0.608		0.620	
е		5.45			0.214		
L	14.20		14.80	0.560		0.582	
L1	3.70		4.30	0.14		0.17	
L2		18.50			0.728		
øΡ	3.55		3.65	0.140		0.143	
øR	4.50		5.50	0.177		0.216	
S		5.50			0.216		



# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	1	Complete version
21-Jun-2005	2	The word "STripFET" in the description title on the web was been corrected
17-Aug-2006	3	The document has been reformatted
31-Jan-2007	4	Typo mistake on <i>Table 1</i> .
03-May-2007	5	R <sub>DS(on)</sub> Max value has been changed

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